Vishay Siliconix

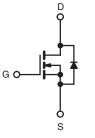


E Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.18				
Q _g max. (nC)	110					
Q _{gs} (nC)	15					
Q _{gd} (nC)	32					
Configuration	Single					

TO-247AC





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of

compliance please see <u>www.vishay.com/doc?99912</u> Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

	ORDERING INFORMATION	
Package		TO-247AC
	Lead (Pb)-free	SiHG22N65E-E3
	Lead (Pb)-free and Halogen-free	SiHG22N65E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	650	v		
Gate-Source Voltage			V _{GS}	± 30	V		
Continuous Drain Current (T. 150 °C)	V at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I _D -	22			
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		14	А		
Pulsed Drain Current ^a			I _{DM}	56			
Linear Derating Factor				1.8	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	691	mJ		
Maximum Power Dissipation			P _D	227	W		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 125 °C		d\//dt	70			
Reverse Diode dV/dt ^d			dV/dt	26	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 7 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt = 100$ A/µs, starting $T_J = 25 \ ^\circ C.$

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RoHS



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THERMAL RESISTANCE RAT		L						
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62		°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-		0.55		0/11		
	uplogo othorwi	as noted)						
SPECIFICATIONS ($T_J = 25 \text{ °C}$, U PARAMETER	SYMBOL			200	MIN.	TYP.	MAX.	
Static	STWDOE	123		5113	IVIIIA.		IVIAA.	
Drain-Source Breakdown Voltage	V _{DS}	V	- 0 \/ 2	50	650			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	$V_{GS} = 0 \text{ V}, I_D = 250 \ \mu\text{A}$ Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.74	_	V/°C	
Gate-Source Threshold Voltage (N)					2	0.74	4	V
Gale-Source Theshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	-	4 ± 100	nA	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$			-	_	± 100	μΑ
					_	_	1 ± 1	μ
Zero Gate Voltage Drain Current	I _{DSS}		V _{DS} = 650 V, V _{GS} = 0 V V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C			-	10	μA
Drain-Source On-State Resistance	Brach	$V_{DS} = 320 V_{SS} = 10 V$		= 11 A	-	- 0.15	0.18	Ω
Forward Transconductance	R _{DS(on)}		_S = 8 V, I _D =		-	6.7	0.10	S S
Dynamic	9 _{fs}	VD:	s = 0 v, 1 _D =	37		0.7		3
Input Capacitance	C _{iss}					2415	_	1
Output Capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to 520 V}, V_{GS} = 0 V$			118	_	pF	
Reverse Transfer Capacitance	C _{rss}			_	4	_		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	89	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	307	-		
Total Gate Charge	Qg				-	73	110	1
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 11 A	, V _{DS} = 520 V	-	15	-	nC
Gate-Drain Charge	Q _{gd}		D		-	32	-	
Turn-On Delay Time	t _{d(on)}				-	22	45	
Rise Time	t _r	- Vpp -	= 520 V, I _D =	11 A	-	33	66	
Turn-Off Delay Time	t _{d(off)}		= 10 V, R _g =		-	73	110	ns
Fall Time	t _f			-	38	76	1	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.64	-	Ω	
Drain-Source Body Diode Characteristi		•						
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22		
Pulsed Diode Forward Current	I _{SM}			-	-	56	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ dl/dt = 100 A/ μ s, V _R = 400 V		-	400	-	ns	
Reverse Recovery Charge	Q _{rr}			-	5.9	-	μ	
Reverse Recovery Current	I _{RRM}			-	20	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

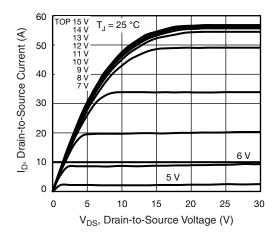


Fig. 1 - Typical Output Characteristics

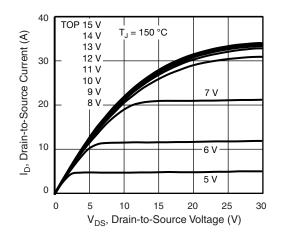
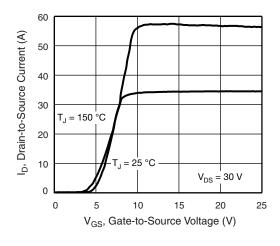


Fig. 2 - Typical Output Characteristics





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3 On Resistance (Normalized) 2.5 R_{DS(on)}, Drain-to-Source 2 1.5 10 V 1 V_{GS} = 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

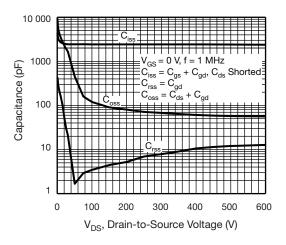


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

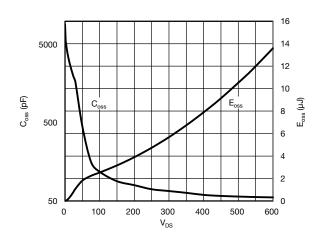


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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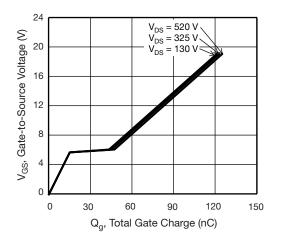


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

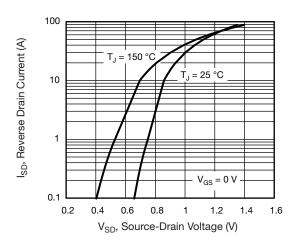


Fig. 8 - Typical Source-Drain Diode Forward Voltage

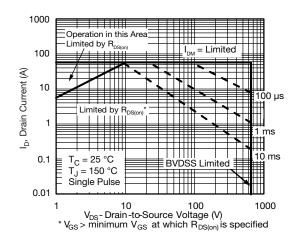


Fig. 9 - Maximum Safe Operating Area

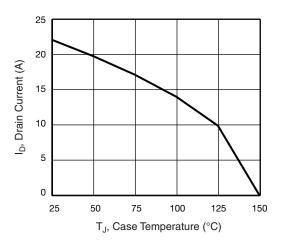


Fig. 10 - Maximum Drain Current vs. Case Temperature

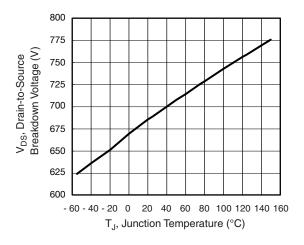
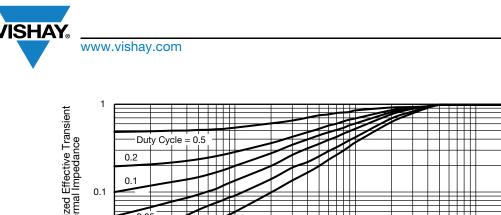


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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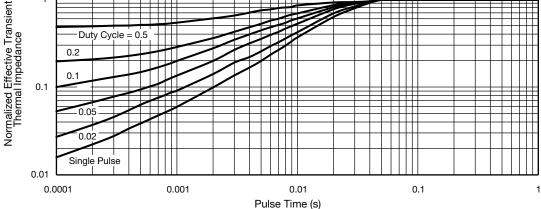


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

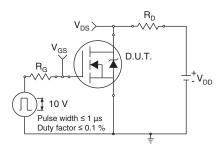


Fig. 13 - Switching Time Test Circuit

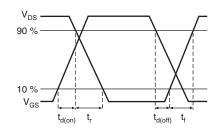


Fig. 14 - Switching Time Waveforms

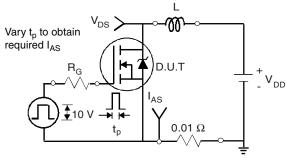


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

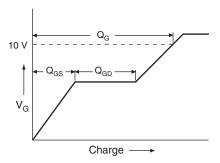
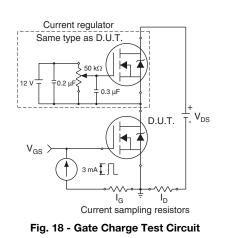


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

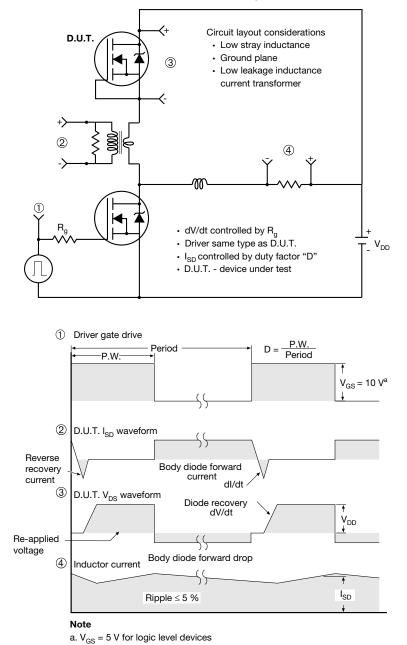


Fig. 19 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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